

MOSFET

OptiMOS[™]3 Power-Transistor, 150 V

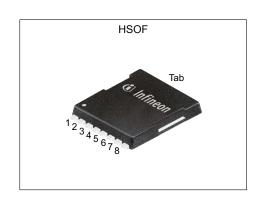
Features

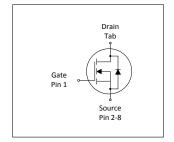
- N-channel, normal level

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 Excellent gate charge x R_{DS(on)} product (FOM)
 Very low on-resistance R_{DS(on)}
 175 °C operating temperature
 Pb-free lead plating; RoHS compliant
 Qualified according to JEDEC¹⁾ for target application
 Ideal for high-frequency switching and synchronous rectification
 Halogen-free according to IEC61249-2-21



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Parameter	Value	Unit				
$V_{ extsf{DS}}$	150	V				
R _{DS(on),max}	5.9	mΩ				
I _D	155	A				











Type / Ordering Code	Package	Marking	Related Links
IPT059N15N3	PG-HSOF-8	059N15N3	-

OptiMOS[™]3 Power-Transistor, 150 V IPT059N15N3



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OptiMOS[™]3 Power-Transistor, 150 V iPT059N15N3



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 **Maximum ratings**

Parameter	Cumbal		Values			Note / Total Constitution
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current	I _D	-	-	155 110	А	T _C =25 °C T _C =100 °C
Pulsed drain current ¹⁾	I _{D,pulse}	-	-	620	Α	<i>T</i> _C =25 °C
Avalanche energy, single pulse	E AS	-	-	520	mJ	$I_{\rm D}$ =150 A, $R_{\rm GS}$ =25 Ω
Gate source voltage	V _{GS}	-20	-	20	V	-
Power dissipation	P _{tot}	-	-	375	W	<i>T</i> _C =25 °C
Operating and storage temperature	T _j , T _{stg}	-55	-	175	°C	IEC climatic category; DIN IEC 68-1: 55/175/56

2 Thermal characteristics

Table 3 Thermal characteristics

Dovomotor	Cumbal	Values			Unit	Note / Took Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - case	R _{thJC}	-	0.2	0.4	K/W	-
Thermal resistance, junction - ambient, minimal footprint	R _{thJA}	-	-	62	K/W	-
Thermal resistance, junction - ambient, 6 cm2 cooling area ²⁾	R _{thJA}	-	-	40	K/W	-

3 **Electrical characteristics**

 Table 4
 Static characteristics

Domeston.	0		Values			
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	150	-	-	V	V _{GS} =0 V, I _D =1 mA
Gate threshold voltage	V _{GS(th)}	2	3	4	V	V _{DS} =V _{GS} , I _D =270 μA
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1 100	μΑ	V _{DS} =120 V, V _{GS} =0 V, T _j =25 °C V _{DS} =120 V, V _{GS} =0 V, T _j =125 °C
Gate-source leakage current	I _{GSS}	-	1	100	nA	V _{GS} =20 V, V _{DS} =0 V
Drain-source on-state resistance	R _{DS(on)}	-	5 5.2	5.9 6.2	mΩ	V _{GS} =10 V, I _D =150 A V _{GS} =8 V, I _D =75 A
Gate resistance	R _G	-	2.1	3.2	Ω	-
Transconductance	g fs	86	172	-	S	

 $^{^{1)}}$ See figure 3 $^{2)}$ Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 μm thick) copper area for drain connection. PCB is vertical in still air.

OptiMOS[™]3 Power-Transistor, 150 V IPT059N15N3



 Table 5
 Dynamic characteristics

Parameter	Cymbol	Values			Unit	Note / Took Condition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance	Ciss	-	5400	7182	pF	V _{GS} =0 V, V _{DS} =75 V, <i>f</i> =1 MHz
Output capacitance	Coss	-	630	838	pF	V _{GS} =0 V, V _{DS} =75 V, f=1 MHz
Reverse transfer capacitance	C _{rss}	-	10	19	pF	V _{GS} =0 V, V _{DS} =75 V, f=1 MHz
Turn-on delay time	$t_{\sf d(on)}$	_	25	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =1.6 Ω
Rise time	t _r	-	35	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =1.6 Ω
Turn-off delay time	$t_{ m d(off)}$	_	46	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =1.6 Ω
Fall time	t _f	-	14	-	ns	$V_{\rm DD}$ =75 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =100 A, $R_{\rm G,ext}$ =1.6 Ω

Table 6 Gate charge characteristics¹⁾

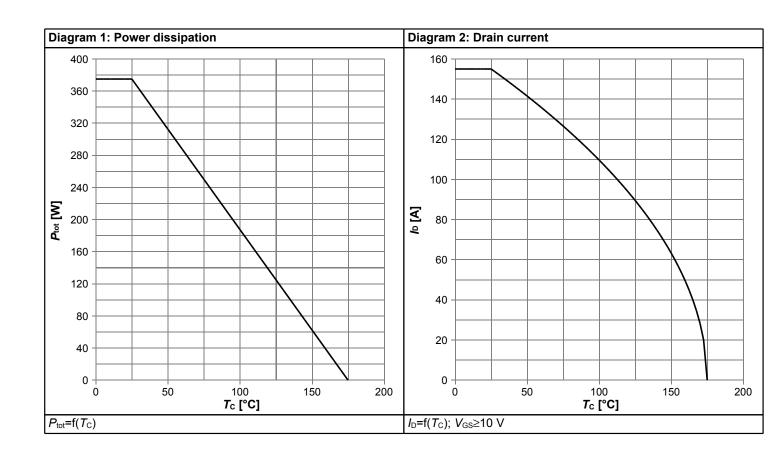
Parameter	Cumbal		Values			Nata / Tank Canadikian
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q _{gs}	-	29	-	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =100 A, $V_{\rm GS}$ =0 to 10 V
Gate to drain charge	$Q_{ m gd}$	-	11	-	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =100 A, $V_{\rm GS}$ =0 to 10 V
Switching charge	Q _{sw}	-	24	-	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =100 A, $V_{\rm GS}$ =0 to 10 V
Gate charge total	Q g	-	69	92	nC	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =100 A, $V_{\rm GS}$ =0 to 10 V
Gate plateau voltage	V _{plateau}	-	5.4	-	V	$V_{\rm DD}$ =75 V, $I_{\rm D}$ =100 A, $V_{\rm GS}$ =0 to 10 V
Output charge	Qoss	-	178	-	nC	V _{DD} =75 V, V _{GS} =0 V

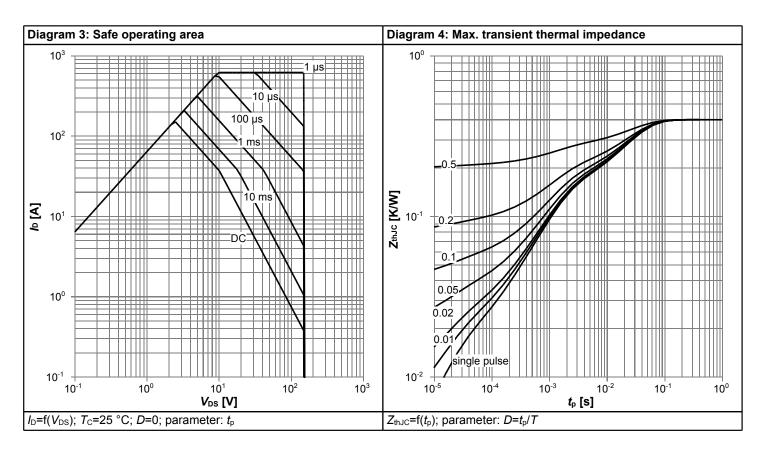
Table 7 Reverse diode

Parameter	Cumbal	Values			Unit	Note / Test Condition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continous forward current	Is	-	-	155	Α	T _C =25 °C
Diode pulse current	I _{S,pulse}	-	-	620	Α	<i>T</i> _C =25 °C
Diode forward voltage	V _{SD}	-	0.94	1.2	V	V _{GS} =0 V, I _F =150 A, T _j =25 °C
Reverse recovery time	<i>t</i> _{rr}	-	146	292	ns	V _R =75 V, I _F =I _S , di _F /dt=100 A/μs
Reverse recovery charge	Qrr	-	478	-	nC	V_R =75 V, I_F = I_S , di_F/dt =100 A/ μ s

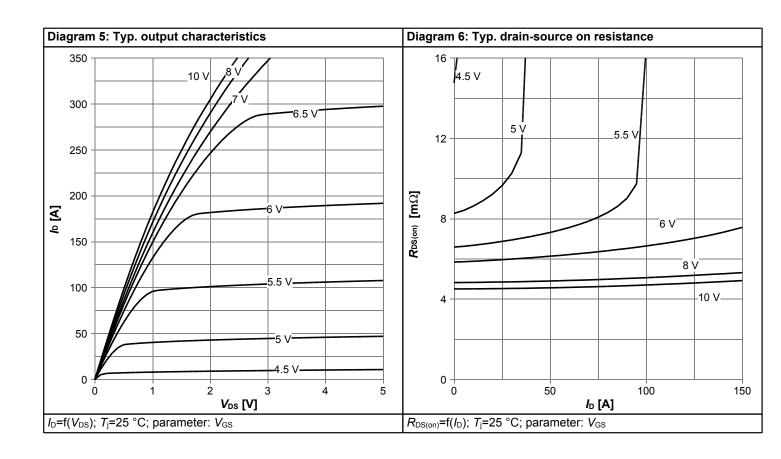


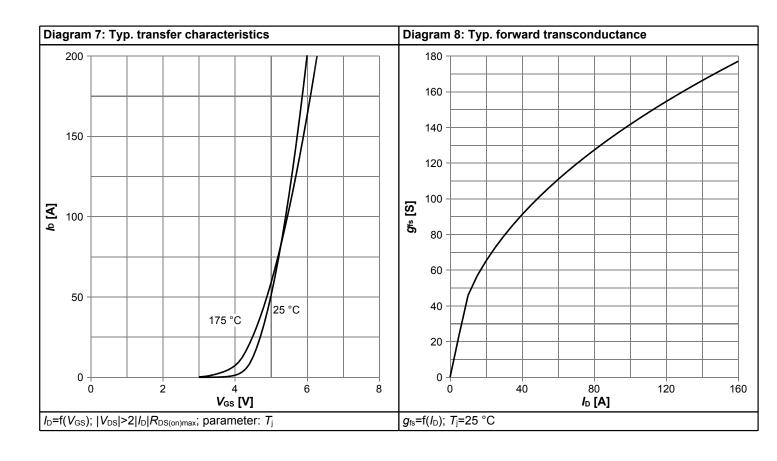
4 Electrical characteristics diagrams



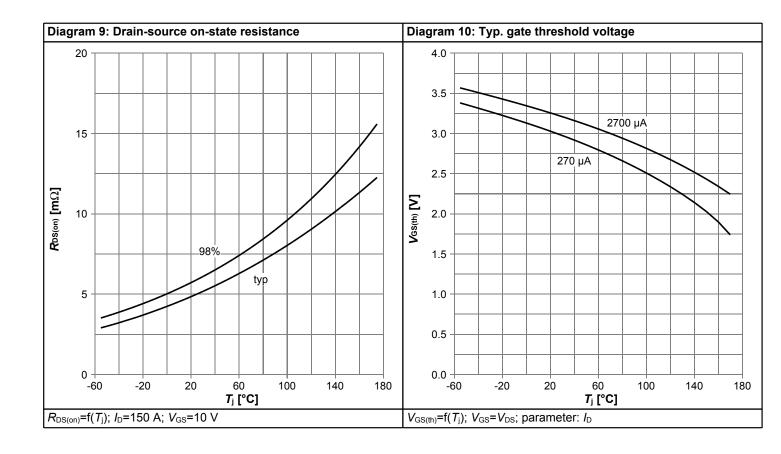


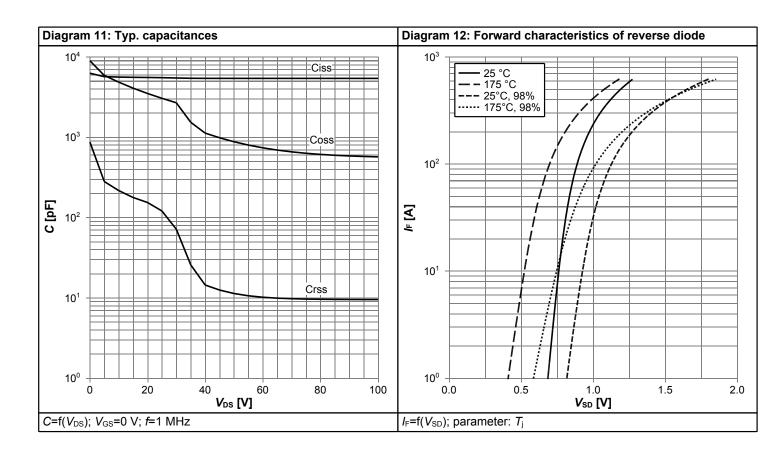




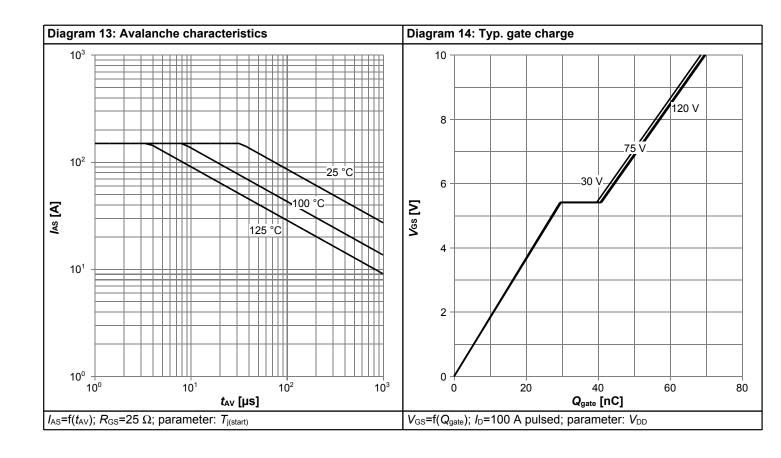


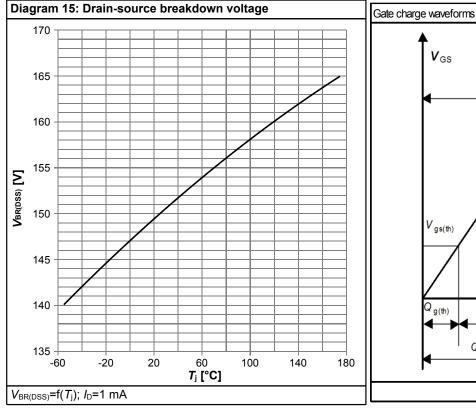


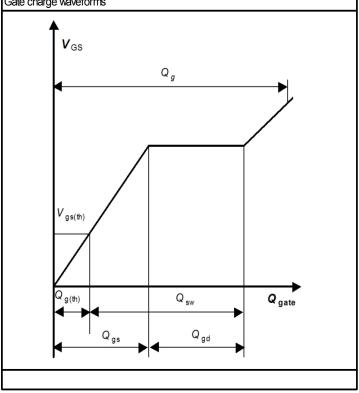














5 Package Outlines

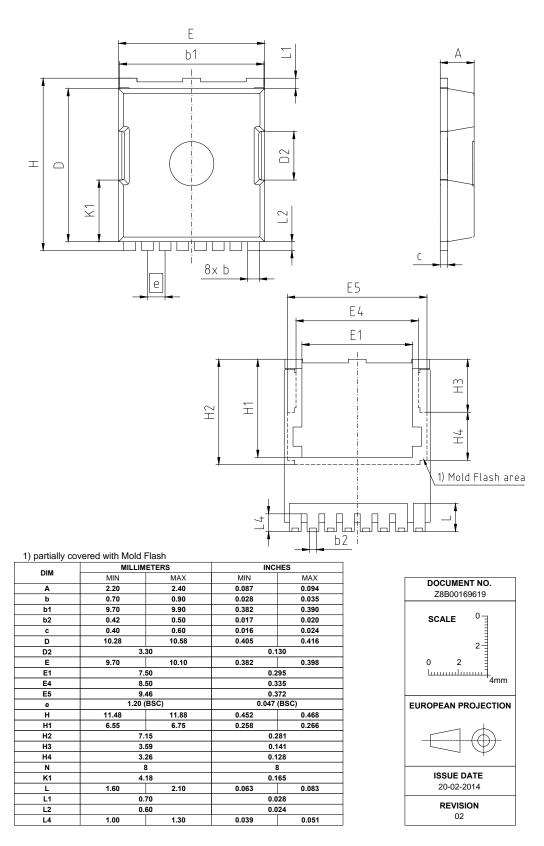


Figure 1 Outline PG-HSOF-8

OptiMOS[™]3 Power-Transistor, 150 V IPT059N15N3



Revision History

IPT059N15N3

Revision: 2017-05-16, Rev. 2.2

Previous Revision

Revision	Date	Subjects (major changes since last revision)
2.0	2014-01-27	Release of final version
2.1	2014-02-07	Insert aditional typ value (Rthjc) and max values (Crss,trr, Rg,Qg, Coss, Ciss)
2.2	2017-05-16	Update Zth Diagram and "T" condition in "Maximum ratings"

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